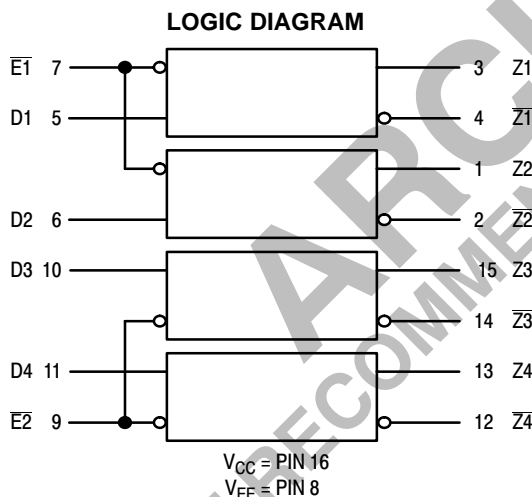


MC10192

Quad Bus Driver

The MC10192 contains four line drivers with complementary outputs. Each driver has a Data (D) input and shares an Enable (\bar{E}) input with another driver. The two driver outputs are the uncommitted collectors of a pair of NPN transistors operating as a current switch. Each driver accepts 10K MECL input signals and provides a nominal signal swing of 800 mV across a 50 Ω load at each output collector. Outputs can drive higher values of load resistance, provided that the combination of I_R drop and load return voltage V_{LR} does not cause an output collector to go more negative than -2.4 V with respect to V_{CC} . To avoid output transistor breakdown, the load return voltage should not be more positive than +5.5 V with respect to V_{CC} . When the \bar{E} input is high, both output transistors of a driver are nonconducting. When not used, the \bar{E} inputs, as well as the D inputs, may be left open.

- Open Collector Outputs Drive Terminated Lines or Transformers
- 50 k Ω Input Pulldown Resistors on All Inputs (Unused Inputs May Be Left Open)
- Power Dissipation = 575 mW typ/pkg (No Load)
- Propagation Delay = 3.5 ns typ (\bar{E} — Output)
3.0 ns typ (D — Output)



TRUTH TABLE

Inputs		Output	
\bar{E}	D	Z	\bar{Z}
H	X	H	H
L	H	H	L
L	L	L	H

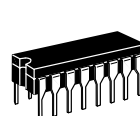
Note: Unused outputs must be terminated to V_{CC} for proper operation.



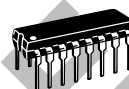
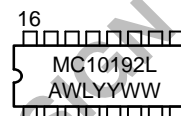
ON Semiconductor

<http://onsemi.com>

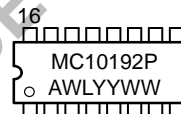
MARKING DIAGRAMS



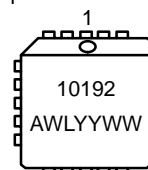
CDIP-16
L SUFFIX
CASE 620



PDIP-16
P SUFFIX
CASE 648

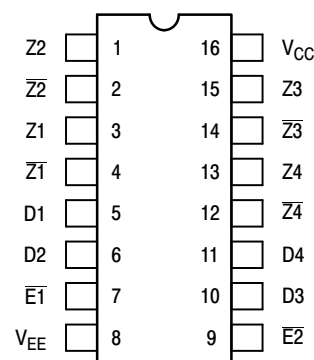


PLCC-20
FN SUFFIX
CASE 775



A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).

ORDERING INFORMATION

Device	Package	Shipping
MC10192L	CDIP-16	25 Units / Rail
MC10192P	PDIP-16	25 Units / Rail
MC10192FN	PLCC-20	46 Units / Rail

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits						Unit
			−30°C		+25°C		+85°C		
			Min	Max	Min	Max	Min	Max	
Power Supply Drain Current	I _E	8		154		140		154	mAdc
Input Current	I _{inH}	5		350		220		220	μAdc
	I _{inL}	5	0.5		0.5		0.3		μAdc
Output Current High Logic 1	I _{OH}	2				2.0			mAdc
Output Current Low Logic 0	I _{OL}	2	13.5	18.0	14.0	18.0	14.0	19.0	mAdc
Threshold Current High Logic 1	I _{OHC}	2		2.0		2.0		2.0	mAdc
Threshold Current Low Logic 0	I _{OLC}	2	13.5		14.0		14.0		mAdc
Output Sink Current Low Logic 0	I _{OS}	2	13.3		13.9		13.3		mAdc
Load Return Voltage Absolute Max Rating (Note 1.)	V _{LR}			5.5		5.5		5.5	V
Output Voltage Low (Note 2.)	V _{OLS}				−2.4				V
Switching Times (50Ω Load)									ns
Propagation Delay \bar{E} to Output	t _{PHL}				2.0	6.0			
D to Output	t _{PLH}				1.5	4.5			
Rise/Fall Time (20 to 80%)	t _{TLH} t _{THL}					3.3			

1. The 5.5V value is a maximum rating, do not exceed. A 270 Ω resistor will prevent output transistor breakdown.
2. Limitations of load resistor and load return voltage combinations. Refer to page 1 description.

ELECTRICAL CHARACTERISTICS (continued)

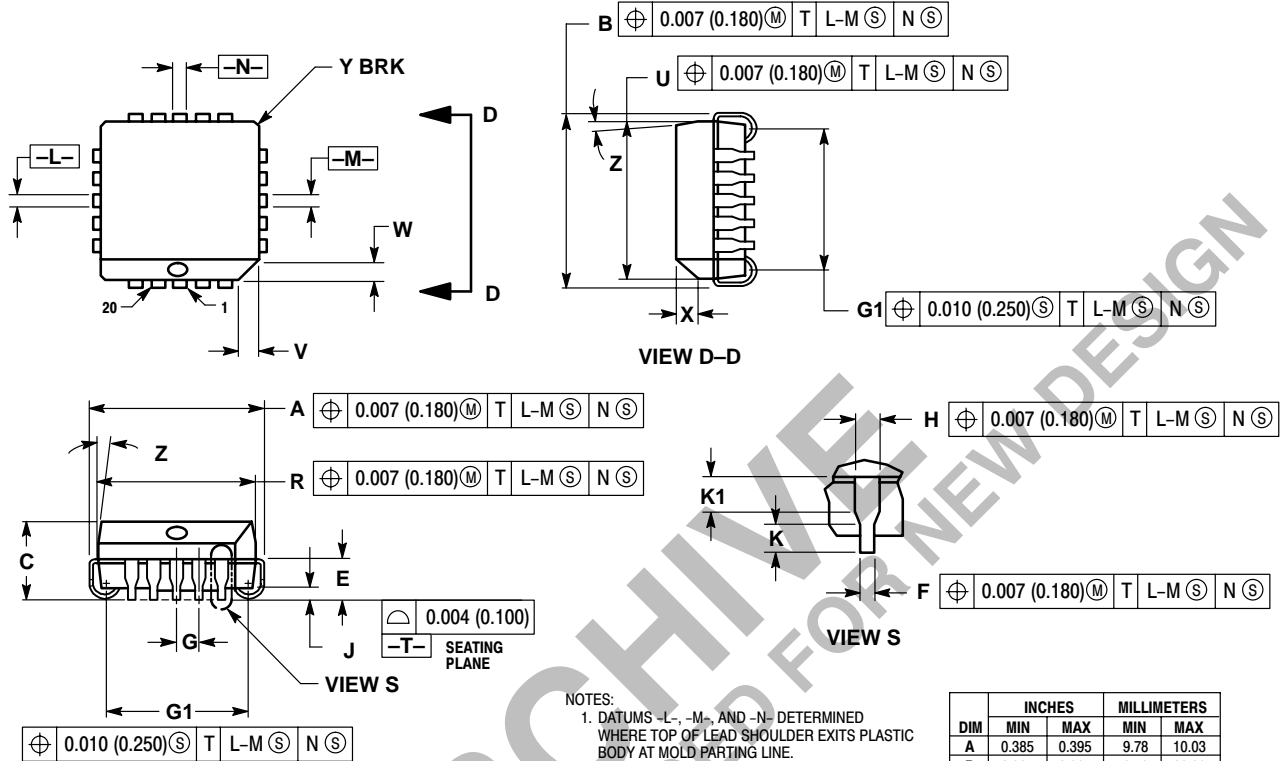
@ Test Temperature			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
-30°C			-0.890	-1.890	-1.205	-1.500	-5.2	
+25°C			-0.810	-1.850	-1.105	-1.475	-5.2	
+85°C			-0.700	-1.825	-1.035	-1.440	-5.2	
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					(V _{CC}) Gnd
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
Power Supply Drain Current	I_E	8					8	16
Input Current	I_{inH}	5	5				8	16
	I_{inL}	5		5			8	16
Output Current High Logic 1	I_{OH}	2		5,6,10,11			8	16
Output Current Low Logic 0	I_{OL}	2	5,6,10,11				8	16
Threshold Current High Logic 1	I_{OHC}	2		5,7,9,10,11		6	8	16
Threshold Current Low Logic 0	I_{OLC}		5,10,11	7,9	6		8	16
Output Sink Current Low Logic 0	I_{OS}	2	5,6,10,11				8	16
Load Return Voltage Absolute Max Rating (Note 1.)	V_{LR}						8	16
Output Voltage Low (Note 2.)	V_{OLS}						8	16

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

MC10192

PACKAGE DIMENSIONS

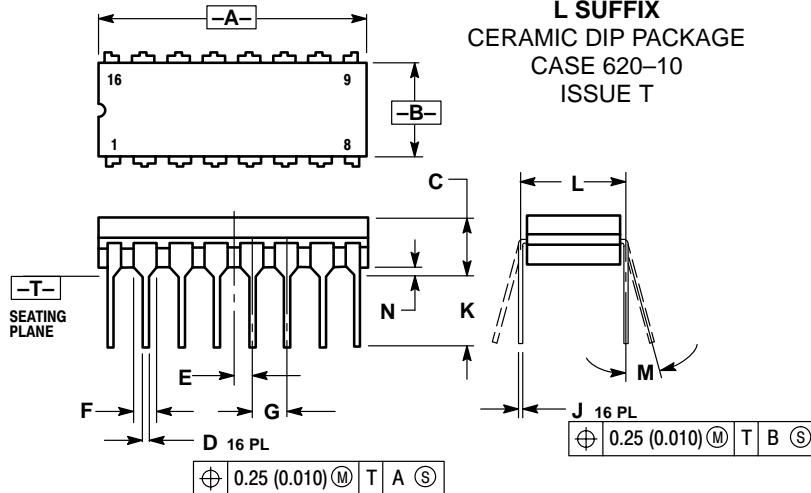
PLCC-20
FN SUFFIX
PLASTIC PLCC PACKAGE
CASE 775-02
ISSUE C



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.385	0.395	9.78	10.03
B	0.385	0.395	9.78	10.03
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	---	0.51	---
K	0.025	---	0.64	---
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	---	0.020	---	0.50
Z	2 °	10 °	2 °	10 °
G1	0.310	0.330	7.88	8.38
K1	0.040	---	1.02	---

MC10192

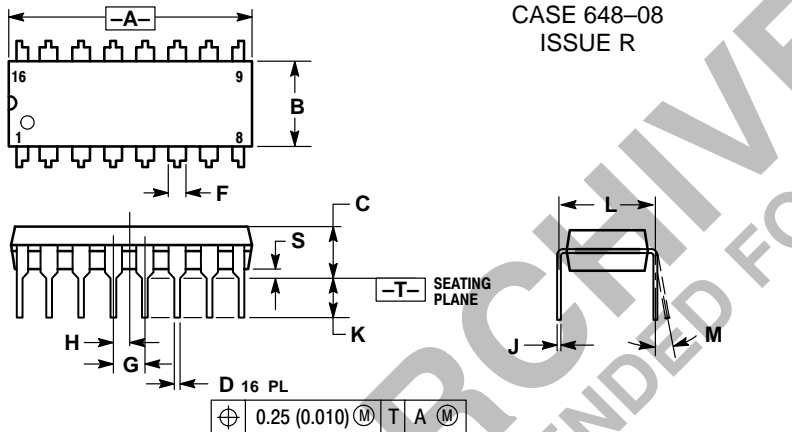
CDIP-16 L SUFFIX CERAMIC DIP PACKAGE CASE 620-10 ISSUE T



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
 4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.


DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	---	0.200	---	5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

PDIP-16 P SUFFIX PLASTIC DIP PACKAGE CASE 648-08 ISSUE R



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

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